PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6158192

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HYUN BAE LEE	06/15/2020

RECEIVING PARTY DATA

Name:	SK HYNIX INC.	
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City:	ICHEON-SI GYEONGGI-DO	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16903951

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	PA3756-1C	
NAME OF SUBMITTER:	W. WILLIAM PARK	
SIGNATURE:	/W. William Park/	
DATE SIGNED: 06/17/2020		
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 1

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PATENT 506111469 REEL: 052965 FRAME: 0236

DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention	RECEPTION CIRCUIT, SEMICONDUCTOR APPARATUS AND SEMICONDUCTOR SYSTEM INCLUDING THE RECEPTION CIRCUIT		
Declaration	As the below named inventor(s), I hereby declare that: The declaration is directed to: The attached application, or United States application or PCT international application number PCT/KR####################################		
Assignment	legal representatives of the assignee(s) to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney. Assignment, application, whether original, continuation, divisional or reissue, or other papers that may be necessary. I hereby covenant that no assignment, sale agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. I further covenant that assignee(s) will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to me and will testify as to the same in any litigation related thereto and will promptly execute and deliver to assignee(s) or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.		
Legal Name Of Inventor	Inventor Name (First Middle LAST):	Hyun Bae LEE ਜਨ੍ਹਾ ਲੋਵ Lee	
		June 15, 2020	

A total of _ supplemental sheet(s) are attached hereto for additional inventors, if any.

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退訊當/System Integrity Innovation

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